

# MOTOROLA SEMICONDUCTOR TECHNICAL DATA

T-33-05

## The RF Line UHF Power Transistors

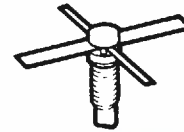
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The TP3010/S are designed for 12.5 V, 900 MHz common-emitter amplifiers operating in the 820–960 MHz frequency region.

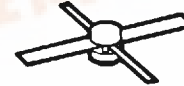
- 900 MHz
- 1.5 W —  $P_{out}$
- 12.5 V —  $V_{CC}$
- 7 dB Min Gain

### TP3010 TP3010S

1.5 W to 900 MHz  
UHF POWER  
TRANSISTORS  
NPN SILICON



CASE 305B-01, STYLE 1  
(.200 SOE)  
TP3010



CASE 305C-01, STYLE 1  
(.200 SOE S)  
TP3010S

#### MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Collector-Emitter Voltage	$V_{CEO}$	16	Vdc
Collector-Base Voltage	$V_{CBO}$	30	Vdc
Emitter-Base Voltage	$V_{EBO}$	3	Vdc
Collector Current — Continuous	$I_C$	2	Adc
Operating Junction Temperature	$T_J$	200	°C
Storage Temperature Range	$T_{stg}$	-50 to +200	°C

#### THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction to Case	$R_{\theta JC}$	14	°C/W

#### ELECTRICAL CHARACTERISTICS ( $T_C = 25^\circ\text{C}$ unless otherwise noted)

Characteristic	Symbol	Min	Typ	Max	Unit
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#### OFF CHARACTERISTICS

Collector-Emitter Breakdown Voltage ( $I_C = 25\text{ mA}$ , $I_B = 0$ )	$V_{(BR)CEO}$	16	—	—	Vdc
Collector-Base Breakdown Voltage ( $I_C = 4\text{ mA}$ , $I_E = 0$ )	$V_{(BR)CBO}$	30	—	—	Vdc
Emitter-Base Breakdown Voltage ( $I_E = 1\text{ mA}$ , $I_C = 0$ )	$V_{(BR)EBO}$	3	—	—	Vdc
Collector Cutoff Current ( $V_{CB} = 15\text{ V}$ , $I_E = 0$ )	$I_{CBO}$	—	—	0.4	mAdc

#### ON CHARACTERISTICS

DC Current Gain ( $I_C = 320\text{ mA}$ , $V_{CE} = 10\text{ V}$ )	$h_{FE}$	25	—	—	—
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#### DYNAMIC CHARACTERISTICS

Output Capacitance ( $V_{CB} = 12.5\text{ V}$ , $I_E = 0$ , $f = 1\text{ MHz}$ )	$C_{ob}$	—	—	8	pF
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#### FUNCTIONAL TESTS

Common-Emitter Amplifier Power Gain ( $V_{CE} = 12.5\text{ V}$ , $P_{out} = 1.5\text{ W}$ , $f = 900\text{ MHz}$ )	$G_{PE}$	7	—	—	dB
Collector Efficiency ( $V_{CE} = 12.5\text{ V}$ , $P_{out} = 1.5\text{ W}$ , $f = 900\text{ MHz}$ )	$\eta_c$	55	—	—	%
Load Mismatch ( $V_{CE} = 16\text{ V}$ , $P_{out} = 1.5\text{ W}$ , $f = 900\text{ MHz}$ , Load VSWR = $\infty:1$ , All Phase Angles)	$\psi$	No Degradation in Output Power			

MOTOROLA RF DEVICE DATA

2-1176

TYPICAL CHARACTERISTICS

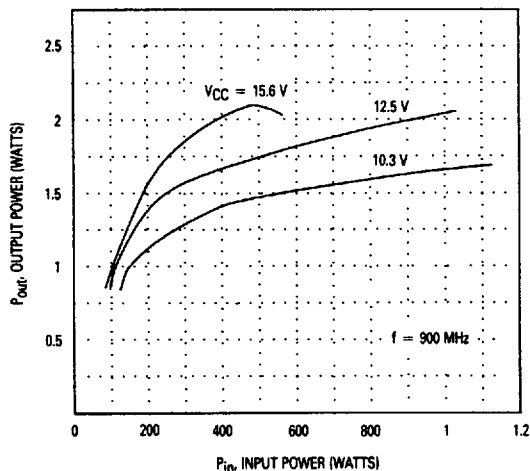
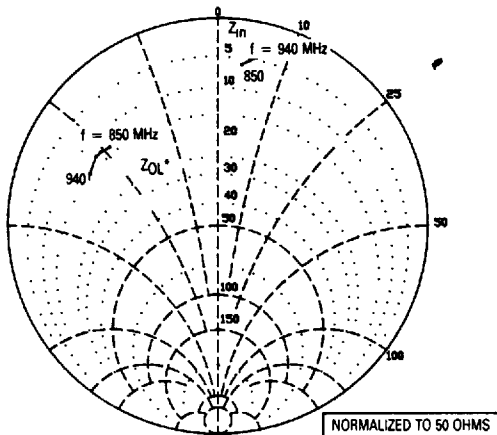


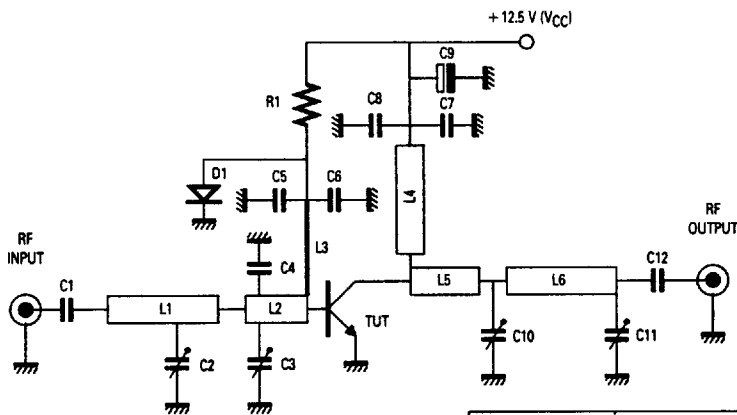
Figure 1. Output Power versus Input Power

$Z_{OL}^*$  = Conjugate of the optimum load impedance into which the device output operates at a given output power, voltage and frequency



f (MHz)	$Z_{in}$ (Ohm)	$Z_{OL}^*$ (Ohms)
850	$6.6 + j3.4$	$14 - j24$
880	$5.9 + j4.7$	$13.9 - j26$
900	$5.4 + j5.6$	$13.8 - j27$
940	$4.7 + j7.85$	$15.2 - j32$

Figure 2. Series Equivalent Input/Output Impedances

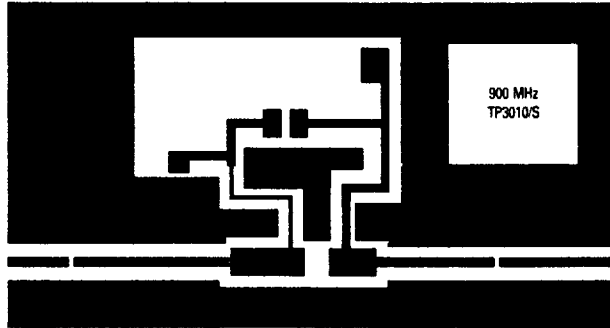


Note: Amplifier tunable from 820 to 960 MHz.  
 Instantaneous Bandwidth — 40 MHz Typ.

C1, C5, C7, C12	Capacitor Chip 330 pF CGO SMT
C2, C3, C10, C11	0.5-5 pF GKU Trimmer Capacitor
C4	Capacitor Chip 3.9 pF
C6, C8	Capacitor Chip 15 nF
C9	Electrolytic Capacitor 10 MF 16 V
R1	Resistor // 2 x 270 Ohms 1/2 W
D1	0.57 for Class B Operation
L1	15 mm $Z_0 = 50$ Ohm
L2, L5	7 mm $Z_0 = 25$ Ohm
L3	27 mm $Z_0 = 75$ Ohm
L4	20 mm $Z_0 = 50$ Ohm
L6	28 mm $Z_0 = 50$ Ohm
Board Material	020 in. $\epsilon_r = 2.55$ , Teflon Glass

Figure 3. Broadband Amplifier Circuit

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Board Material: .020 in. Glass Teflon  $\epsilon_r = 2.55$

Figure 4. Printed Circuit Board Layout (Not to Scale)

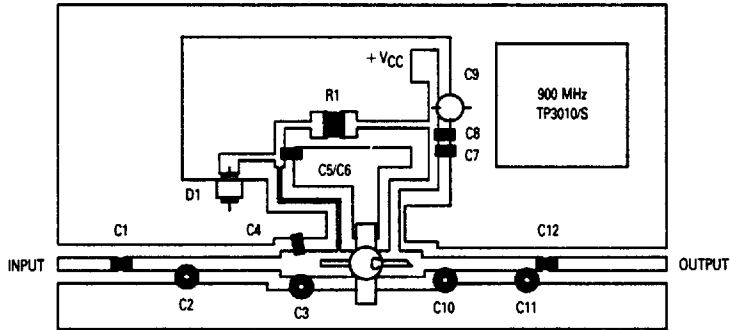


Figure 5. Component Layout